

TE Internal #: 1473005-1 SO DIMM Sockets, Double Data Rate (DDR), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 200 Position, .024 in [.6 mm] Centerline

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DRAM Type: Double Data Rate (DDR) Stack Height: 5.2 mm [.205 in] Module Orientation: Right Angle Connector System: Cable-to-Board Number of Positions: 200

All DDR2 SO DIMM Sockets (30)



Features

Product Type Features

DRAM Type	Double Data Rate (DDR)	
Connector System	Cable-to-Board	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Bays	2	
Number of Keys	1	
Number of Rows	2	
Module Orientation	Right Angle	
Number of Positions	200	
Electrical Characteristics		
DRAM Voltage	2.5 V	
Signal Characteristics		
SGRAM Voltage	2.5 V	

connectivity

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Body Features

I+1 800 522 6752	08/02/2023 0	
Circuit Application	Power	
Operation/Application		
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]	
Usage Conditions		
Row-to-Row Spacing	6.2 mm[.244 in]	
Stack Height	5.2 mm[.205 in]	
Dimensions		
Centerline (Pitch)	.6 mm[.024 in]	
Housing Color	Black	
Housing Material	High Temperature Thermoplastic	
Housing Features		
Connector Mounting Type	Board Mount	
PCB Mount Retention Type	Solder Peg	
PCB Mount Retention	With	
PCB Mounting Style	Surface Mount	
Mating Alignment Type	Standard Keying	
Mechanical Attachment		
Insertion Style	Cam-In	
Termination Features		
Contact Current Rating (Max)	.5 A	
Contact Mating Area Plating Material	Gold Flash	
Contact Base Material	Copper Alloy	
PCB Contact Termination Area Plating Material	Gold Flash	
Memory Socket Type	Memory Card	
Contact Features		
Connector Profile	Standard	
Ejector Type	Locking	
Module Key Type	SGRAM	
Latch Plating Material	Tin	
Latch Material	Stainless Steel	
Ejector Location	Both Ends	

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Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	20
Packaging Method	Semi-Hard Tray Assembly
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Canability	Reflow solder capable to 215°C

Reflow solder capable to 245°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

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Customers Also Bought



	ROW,EP2.5	

TE Part #1-2176267-3 RU 0603 33R2 0.01% 2PPM 1K RL

Documents

Product Drawings SEMI HARD TRAY DDR SOCKET 200P

English

CAD Files

Customer View Model

ENG_CVM_CVM_1473005-1_J1.2d_dxf.zip

English

3D PDF

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3D

Customer View Model ENG_CVM_CVM_1473005-1_J1.3d_igs.zip English

Customer View Model

ENG_CVM_CVM_1473005-1_J1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English